

Is Now Part of

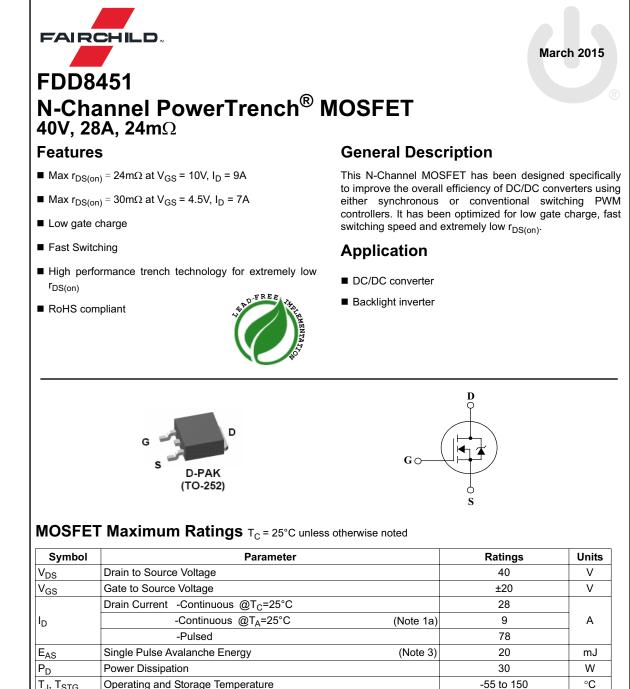


ON Semiconductor®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

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Device Marking

FDD8451

Thermal Characteristics

Thermal Resistance, Junction to Case

Thermal Resistance, Junction to Ambient

Thermal Resistance, Junction to Ambient

Package Marking and Ordering Information

Device

FDD8451

T_J, T_{STG}

 $R_{\theta JC}$

 $R_{\theta,IA}$

 $R_{\theta JA}$

Package

D-PAK(TO-252)

Quantity

2500 units

°C

°C/W

°C/W

°C/W

4.1 40

96

Tape Width

16mm

(Note 1a)

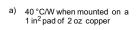
(Note 1b)

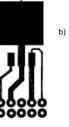
Reel Size

13"

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		33.5		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 32V, V _{GS} = 0V			1	μA
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20V, V _{DS} = 0V			±100	nA
On Chara	icteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA	1	2.1	3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{J}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu$ A, referenced to 25° C		-5.7		mV/°C
r _{DS(on)}	Drain to Source On Resistance	V _{GS} = 10V, I _D = 9A		19	24	mΩ
		V _{GS} = 4.5V, I _D = 7A		23	30	
		V _{GS} = 10V, I _D = 9A T _J = 150°C		32	41	
9 _{FS}	Forward Transcondductance	V _{DS} = 5V, I _D = 9A		29		S
Dynamic C _{iss} C _{oss}	Characteristics Input Capacitance Output Capacitance	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz		780 112	990 150	pF pF
C _{rss}	Reverse Transfer Capacitance			72	110	pF
R _g	Gate Resistance	f = 1MHz		1.1		Ω
Oitakin.	g Characteristics					
	-			7	14	ns
t _{d(on)}	Turn-On Delay Time	V _{DD} = 20V, I _D = 9A		7	14 10	ns ns
t _{d(on)} t _r	Turn-On Delay Time Rise Time	V_{DD} = 20V, I _D = 9A V_{GS} = 10V, R _{GEN} = 6 Ω		7 3 19	14 10 34	ns ns ns
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time			3	10	ns
t _{d(on)} t _r t _{d(off)} t _f	Turn-On Delay Time Rise Time Turn-Off Delay Time			3 19	10 34	ns ns
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time			3 19 2	10 34 10	ns ns ns
$\begin{array}{c} t_{d(on)} \\ t_{r} \\ t_{d(off)} \\ t_{f} \\ Q_{g} \end{array}$	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V	V _{GS} = 10V, R _{GEN} = 6Ω		3 19 2 16	10 34 10 20	ns ns ns nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Total Gate Charge at 5V	$V_{GS} = 10V, R_{GEN} = 6\Omega$		3 19 2 16 8.6	10 34 10 20	ns ns ns nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Total Gate Charge at 5V Gate to Source Gate Charge	$V_{GS} = 10V, R_{GEN} = 6\Omega$		3 19 2 16 8.6 2.5	10 34 10 20	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd} Drain-So	Turn-On Delay TimeRise TimeTurn-Off Delay TimeFall TimeTotal Gate Charge at 10VTotal Gate Charge at 5VGate to Source Gate ChargeGate to Drain "Miller"Charge	$V_{GS} = 10V, R_{GEN} = 6Ω$ $V_{DS} = 20V, I_D = 9A$ $V_{GS} = 10V$ e $V_{GS} = 0V, I_S = 9A$		3 19 2 16 8.6 2.5	10 34 10 20	ns ns nC nC nC
t _{d(on)} t _r t _{d(off)} t _f Q _g Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Total Gate Charge at 5V Gate to Source Gate Charge Gate to Drain "Miller"Charge urce Diode Characteristics	V_{GS}^{-} = 10V, R_{GEN} = 6Ω V_{DS} = 20V, I_{D} = 9A V_{GS} = 10V		3 19 2 16 8.6 2.5 3.7	10 34 10 20 11	ns ns nC nC nC nC

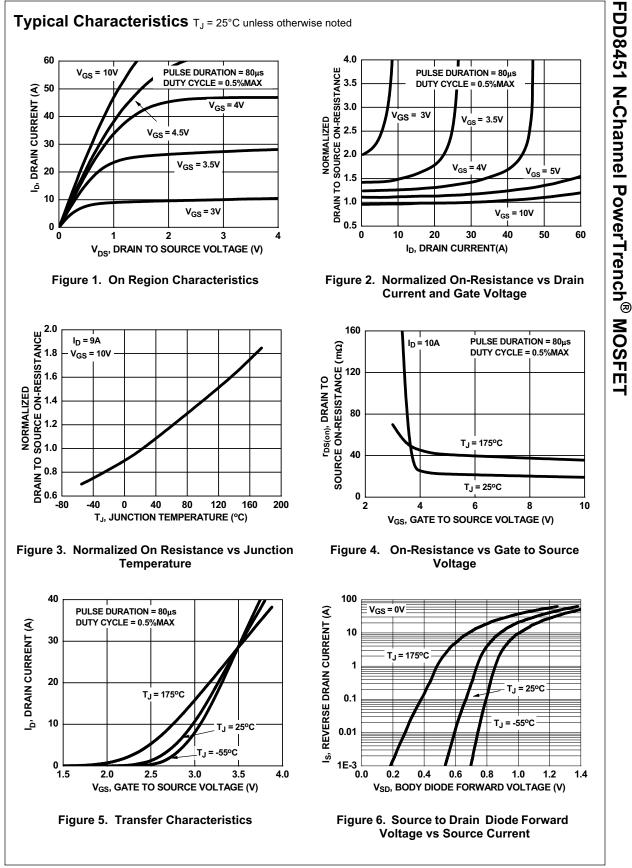




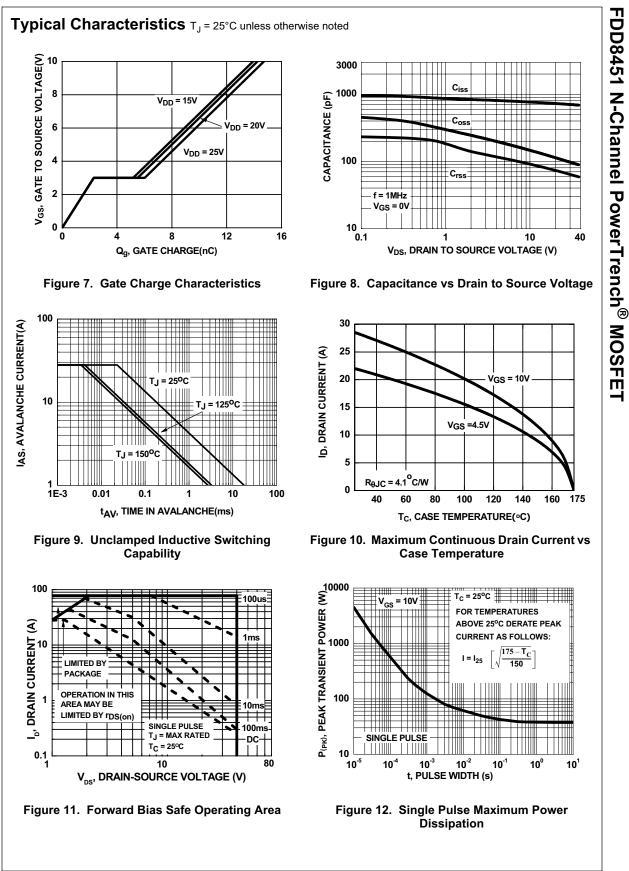


96 °C/W when mounted on a minimum pad

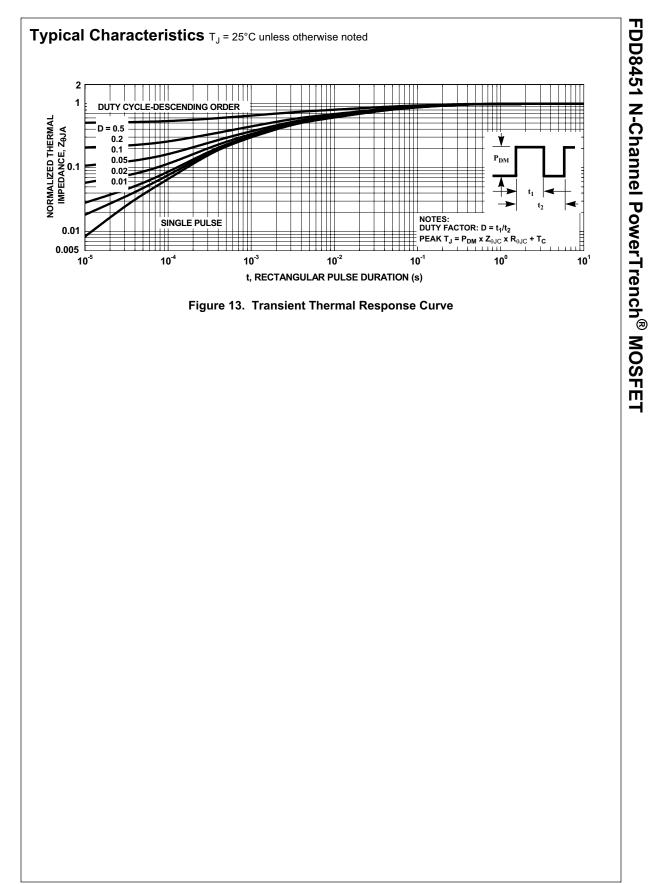
FDD8451 N-Channel PowerTrench[®] MOSFET



FDD8451 Rev. 1.2



FDD8451 Rev. 1.2





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